High Resolution Slotted Optical Switch

OPB821TX

Obsolete (OPB821TXV)

Electronics

Features:

- Non-contact switching
- · Low profile to facilitate stacking
- Hermetically sealed components
- 24" (609.60 mm) minimum length wire conforms to MIL-W-16878
- TX components processed to MIL-PRF-19500



Description:

Each **OPB821TX** device consists of a gallium aluminum arsenide LED and a silicon phototransistor, which are soldered into a printed circuit board and mounted in a high temperature plastic housing on opposite sides of an 0.080" (2.03 mm) wide slot. Lead wires are #24 AWG polytetraflouroethylene (PTFE) insulated, which conforms to MIL-W-16878.

Phototransistor switching takes place when an opaque object passes through the slot. For maximum output signal, neither the LED nor the phototransistor is apertured.

TX device components are processed to OPTEK's military screening program patterned after MIL-PRF-19500.

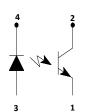
Please refer to Application Bulletins 208 and 210 for additional design information and reliability (degradation) data.

Contact your local representative or OPTEK for more information.

Applications:

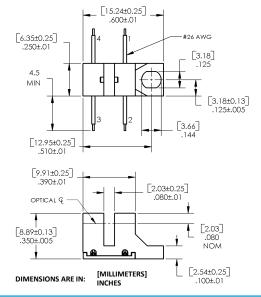
- Non-contact object sensing
- Assembly line automation
- Machine automation
- · Equipment safety
- · Machine safety

Part Number	LED Peak Wavelength	Sensor	Slot Width / Depth	I _{C(ON)} (mA) Min	I _F (mA) Typ / Max	V _{CE} (Volts) Max	Aperture Emitter/ Sensor	Lead Length / Spacing
OPB821TX	890 nm	Transistor	0.080" / 0.255"	0.80	20 / 50	30	0.040"/ 0.040"	24"/26 AWG wire





Color/Pin#	Description	Color/Pin #	Description		
Green-3	Cathode	White-2	Collector		
Orange-4	Anode	Blue-1	Emitter		



General Note

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Absolute Maximum Rating	$s (T_{\Lambda} = 25^{\circ})$	C unless	otherwise	noted)
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Storage Temperature	-65° C to +150° C
Operating Temperature	-65° C to +125° C
Lead Soldering Temperature (1/16 inch [1.6 mm] from case for 5 seconds with soldering iron) ⁽¹⁾	260° C
Input Diode	
Continuous Forward Current	50 mA
Reverse Voltage	2 V
Power Dissipation ⁽¹⁾	100 mW
Output Phototransistor	
Collector-Emitter Voltage	50 V
Emitter-Collector Voltage	7 V
Power Dissipation ⁽¹⁾	100 mW

Electrical Characteristics (T_A = 25° C unless otherwise noted)

SYMBOL	PARAMETER		TYP	MAX	UNITS	TEST CONDITIONS	
Input Diode							
	Forward Voltage ⁽³⁾	1.00	1.35	1.70	V	I _F = 20 mA	
V_{F}		1.20	1.55	1.90		I _F = 20 mA, T _A = -55° C	
		0.80	1.20	1.60		I _F = 20 mA, T _A = 100° C	
I _R	Reverse Current		0.10	100	μΑ	V _R = 2 V	
Output Photot	ransistor						
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	50	110	-	V	$I_{C} = 1 \text{ mA}, I_{F} = 0$	
$V_{(BR)ECO}$	Emitter-Collector Breakdown Voltage	7	10	-	V	$I_E = 100 \mu A, I_F = 0$	
1	Collector-Emitter Dark Current	-	0.20	100	nA	$V_{CE} = 10 \text{ V, } I_F = 0$	
I _{C(OFF)}		-	10	100	μΑ	$V_{CE} = 10 \text{ V, } I_F = 0, T_A = 100^{\circ} \text{ C}$	
Coupled							
			ı	ı		V _{CE} = 10 V, I _F = 20 mA	
I _{C(ON)}	On-State Collector Current ⁽³⁾	500	ı	ı	μΑ	V _{CE} = 10 V, I _F = 20 mA, T _A = -55° C	
			ı	ı		V _{CE} = 10 V, I _F = 20 mA, T _A = 100° C	
V _{CE(SAT)}	Collector-Emitter Saturation Voltage	-	0.20	0.30	V	I _C = 250 μA, I _F = 20 mA	

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Electrical Characteristics (T_A = 25° C unless otherwise noted)

SYMBOL	OL PARAMETER		TYP	MAX	UNITS	TEST CONDITIONS
Coupled						
t _r	Output Rise Time	-	12	20		V = 10 V L = 20 mA R = 1000 O
t _f	Output Fall Time	-	12	20	μs	$V_{CC} = 10 \text{ V}, I_F = 20 \text{ mA}, R_L = 1000 \Omega$

Notes:

- (1) Derate linearly 1.00 mW/° C above 25° C.
- (2) Methanol or isopropanol are recommended cleaning agents.
- (3) Measurement is taken during the last 500 μs of a single 1.0 ms test pulse. Heating due to increased pulse rate or pulse width can cause change in measurement results.

